MOS FIELD EFFECT TRANSISTOR μ **ΡΑ1742ΤΡ**

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

JEC

The μ PA1742TP is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for high voltage applications such as DC/DC converter.

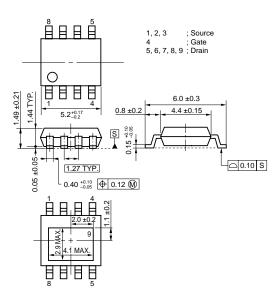
FEATURES

- High voltage: VDSS = 250 V
- Gate voltage rating: ±30 V
- Low on-state resistance $R_{DS(on)} = 0.55 \Omega MAX. (V_{GS} = 10 V, I_{D} = 3.5 A)$
- Low input capacitance $C_{iss} = 460 \text{ pF TYP}. (V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V})$
- Built-in gate protection diode
- Small and surface mount package (Power HSOP8)

ORDERING INFORMATION

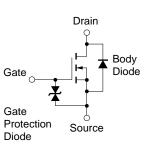
PART NUMBER	PACKAGE
μΡΑ1742TP	Power HSOP8

PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise noted. All terminals are connected.)

Drain to Source Voltage (VGs = 0 V)	Vdss	250	V	
Gate to Source Voltage (Vps = 0 V)	Vgss	±30	V	
Drain Current (DC) (Tc = 25°C)	D(DC)	±7.0	А	
Drain Current (pulse) Note1	D(pulse)	±21	А	
Total Power Dissipation (Tc = 25°C)	Pt1	24	W	
Total Power Dissipation (T _A = 25°C) Note2	PT2	1.0	W	
Channel Temperature	Tch	150	°C	
Storage Temperature	Tstg	–55 to +150	°C	
Single Avalanche Current Note3	las	7.0	А	
Single Avalanche Energy Note3	Eas	4.9	mJ	
Repetitive Avalanche Current Note4	IAR	7.0	А	
Repetitive Pulse Avalanche Energy Note4	EAR	4.9	mJ	
Notes 1 $PW < 10 \mu s$ $Duty Cycle < 1\%$				



EQUIVALENT CIRCUIT

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- 2. Mounted on glass epoxy board of 1 inch x 1 inch x 0.8 mm
- 3. Starting T_{ch} = 25°C, V_{DD} = 125 V, R_G = 25 Ω , L = 100 μ H, V_{GS} = 20 \rightarrow 0 V
- **4.** $T_{ch(peak)} \le 150^{\circ}C, L = 100 \ \mu H$

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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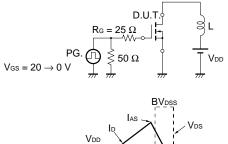
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = 250 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	VGS(off)	V _{DS} = 10 V, I _D = 1 mA	2.5	3.5	4.5	V
Forward Transfer Admittance Note	y _{fs}	Vds = 10 V, Id = 3.5 A	2.5	5		S
Drain to Source On-state Resistance Note	RDS(on)	Vgs = 10 V, Id = 3.5 A		0.41	0.55	Ω
Input Capacitance	Ciss	V _{DS} = 10 V		460		pF
Output Capacitance	Coss	Vgs = 0 V		100		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		45		pF
Turn-on Delay Time	td(on)	Vdd = 125 V, Id = 3.5 A		11		ns
Rise Time	tr	Vgs = 10 V		9		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		24		ns
Fall Time	tr			8		ns
Total Gate Charge	Q _G	V _{DD} = 200 V		14		nC
Gate to Source Charge	QGS	Vgs = 10 V		3		nC
Gate to Drain Charge	Qgd	ID = 7.0 A		7		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 7.0 A, VGS = 0 V		0.9	1.5	V
Reverse Recovery Time	trr	IF = 7.0 A, VGS = 0 V		140		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		560		nC

ELECTRICAL CHARACTERISTICS (T_A = 25°C, unless otherwise noted. All terminals are connected.)

Note Pulsed: PW \leq 800 μ s, Duty Cycle \leq 2%

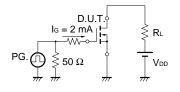
TEST CIRCUIT 1 AVALANCHE CAPABILITY

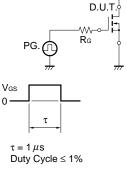
TEST CIRCUIT 2 SWITCHING TIME

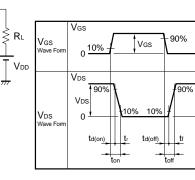


Starting T_{ch}

TEST CIRCUIT 3 GATE CHARGE



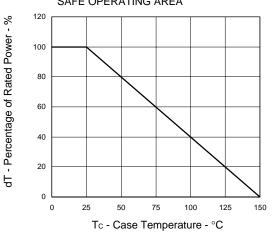


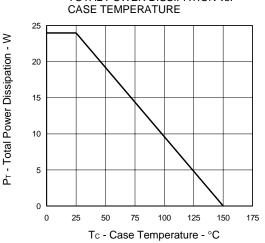




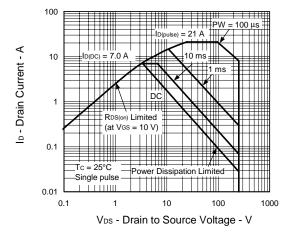


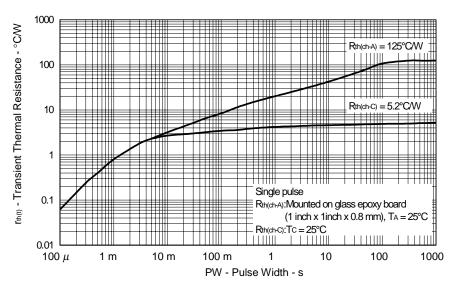
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise noted. All terminals are connected.)



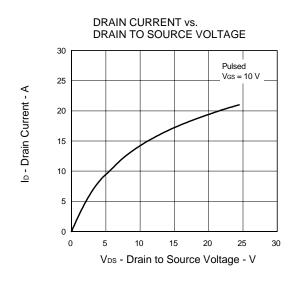


FORWARD BIAS SAFE OPERATING AREA

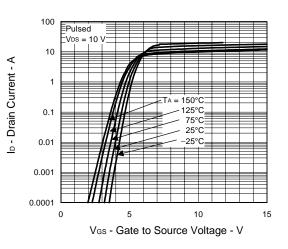




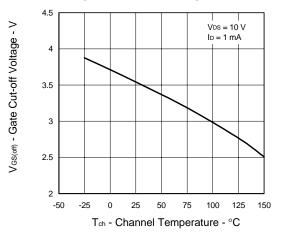
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



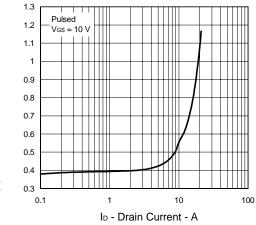
FORWARD TRANSFER CHARACTERISTICS



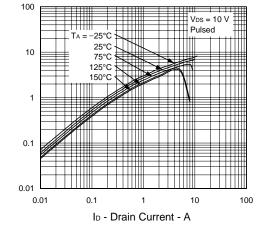
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



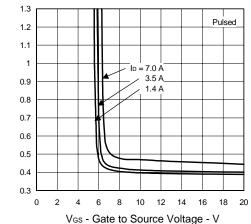
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 $R^{\text{DS}(m)}$ - Drain to Source On-state Resistance - Ω

4

| y_{fs} | - Forward Transfer Admittance - S

 $R_{DS(cn)}$ - Drain to Source On-state Resistance - Ω

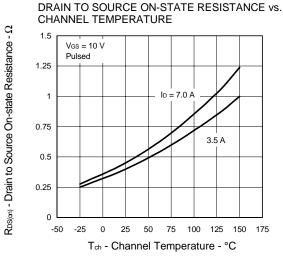
100

10

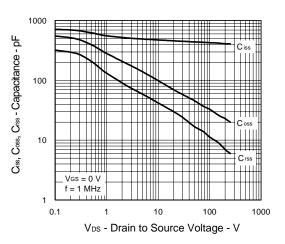
1

0.1

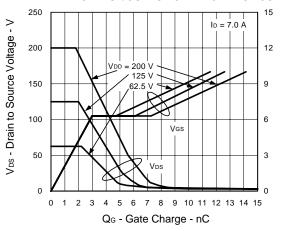
to(on), tr, td(off), tr - Switching Time - ns



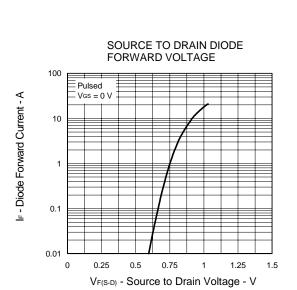
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



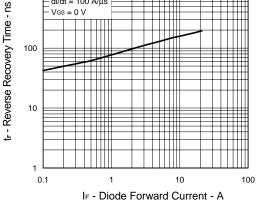
DYNAMIC INPUT/OUTPUT CHARACTERISTICS







REVERSE RECOVERY TIME vs. **DIODE FORWARD CURRENT** ---di/dt = 100 A/µs $V_{GS} = 0 V$



VDD = 125 V

100

VGS = 10 V

 $R_G = 0 \Omega$

SWITCHING CHARACTERISTICS

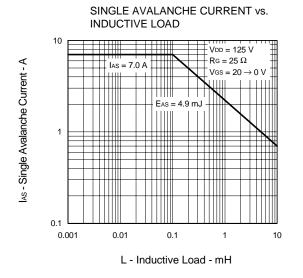
td(off)

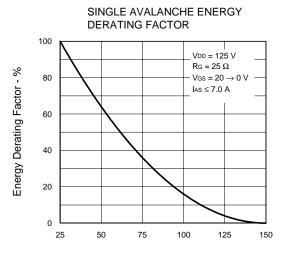
10

ID - Drain Current - A

1

1000





Starting Tch - Starting Channel Temperature - °C

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